

DATA SHEET

SKY66118-11: 2.4 GHz +20 dBm Front-End Module for Bluetooth[®] IoT Applications

Applications

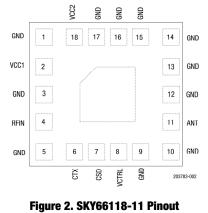
- Wearables
- Personal trackers
- · Smart appliances
- · Smart thermostats
- Smart lighting
- BT connectivity modules
- Internet of Things (IoT) devices

Features

- Integrated PA with up to +20 dBm output power
- · Integrated bypass path, matching and harmonic filtering
- Output power control: ± 1dB
- Wide supply range: 1.7 V to 3.3 V
- Fast switch on/off time: 800 ns
- Low sleep current: < 1 μ A
- Wide temperature range: -40°C to 105°C
- Small MCM (18-pin, 2.6 mm x 2.4 mm x 0.75 mm) package, (MSL3, 260 °C per JEDEC-J-STD-020)



Skyworks Green[™] products are compliant with all applicable legislation and are halogen-free. For additional information, refer to *Skyworks Definition of Green[™]*, document number SQ04–0074.



(Top View)

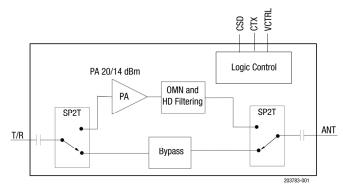


Figure 1. SKY66118-11 Block Diagram

Description

The SKY66118-11 is a high-performance, fully integrated RF front-end module (FEM) designed for Bluetooth, Zigbee[®], and Thread applications.

The SKY66118-11 is designed for ease of use and maximum flexibility. The device integrates a +20 dBm power amplifier, RF switches, output matching, and harmonic filtering. Using simple 2-pin GPIO control, the FEM supports three modes of operation (transmit mode, bypass mode, and an ALL OFF sleep mode). The output power can also be externally adjusted through the VCTRL pin.

A low transmit current consumption and operation over a wide supply range enable the FEM to be used with a direct battery connection, supporting a wide range of battery discharge voltages.

A functional block diagram is shown in Figure 1. The SKY66118-11 is provided in a small, 18-pin, 2.6 mm x 2.4 mm Multi-Chip Module (MCM) package. The pin configuration and package are shown in Figure 2. Signal pin assignments and functional pin descriptions are provided in Table 1.

Pin	Name	Description	Pin	Name	Description
1	GND	Ground	10	GND	Ground
2	VCC1	Connect to positive supply	11	ANT	Connect to 50 Ω antenna
3	GND	Ground	12	GND	Ground
4	RFIN	RF input power	13	GND	Ground
5	GND	Ground	14	GND	Ground
6	CTX	Transmit enable control input (see Table 6)	15	GND	Ground
7	CSD	Shutdown control input (see Table 6)	16	GND	Ground
8	VCTRL	Output power control voltage	17	GND	Ground
9	GND	Ground	18	VCC2	Connect to positive supply

Table 1. SKY66118-11 Signal Descriptions¹

¹ The paddle should be connected to ground.

Electrical and Mechanical Specifications

The absolute maximum ratings of the SKY66118-11 are provided in Table 2. The recommended operating conditions are specified in Table 3, and electrical specifications are provided in Tables 4 and 5. The state of the SKY66118-11 is determined by the logic provided in Table 6.

Table 2. SKY66118-11 Absolute Maximum Ratings¹

Parameter	Symbol	Minimum	Maximum	Units
Supply voltage	Vcc1 Vcc2	-0.3 -0.3	+3.6 +3.6	V V
Control pin voltages (CTX and CSD)	VCTRL	-0.3	+3.6	V
Transmit output power at ANT port into 50 Ω load	Pout_tx_max		+22	dBm
Transmit input power at RFIN port	Pin_tx_max		+5.0	dBm
Bypass input power at ANT port ²	Pin_byp_max		+20	dBm
Operating temperature	Та	-40	+105	°C
Storage temperature	Тята	-40	+125	°C
Electrostatic discharge:	ESD			
Human Body Model (HBM), pin 11 (PAOUT) Human Body Model (HBM), all other pins			500 3000	V V

¹ Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device.

² CW test signal.

ESD HANDLING: Although this device is designed to be as robust as possible, electrostatic discharge (ESD) can damage this device. This device must be protected at all times from ESD when handling or transporting. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD handling precautions should be used at all times.

Table 3. SKY66118-11 Recommended Operating Conditions

Parameter	Symbol	Min	Тур	Мах	Units
Supply voltage on VCC1 pin	Vcc1	1.7	3.0	3.3	V
Supply voltage on VCC2 pin	Vcc2	1.7	3.0	3.3	V
Supply voltage on VCTRL pin	VCTRL	0.6		3.3	V
Operating temperature	Та	-40	+25	+105	°C

Table 4. SKY66118-11 Electrical Specifications¹

(Vcc1 = 3.0 V, Vcc2 = 3.0 V, VctrL = 3.0 V, TA = +25 °C, Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Тур	Max	Units
DC Characteristics						
Total supply current	Ісс_тх	Роит = +20 dBm Роит = +14 dBm		90 55		mA mA
Total supply current	Ісс_вур			5		μA
Sleep supply current	ICC_OFF	No RF			1	μA
Quiescent current	Іссо_тх	No RF		30		mA
Logic Characteristics						
Control voltage (CTX and CSD): High Low	Vih Vil		1.6	1.8 0	VCC1 0.3	V V
Control current (CTX and CSD): High Low	Ін Іц				1.0 1.0	μA μA
VCTRL	VCTRL		0.6		VCC1	V

¹ Performance is guaranteed only under the conditions listed in this table.

Parameter	Symbol	Test Condition	Min	Тур	Мах	Units
Transmit Characteristics		•				
Frequency range	f		2400		2483	MHz
Output power at ANT port	Pout ²	BDR, GFSK EDR-3, 8-DPSK		+20 +14		dBm dBm
Saturated gain	GSAT			19		dB
Flatness over band	ΔΡΟυτ			±0.5		dB
Output power control		1.6 V < VCTRL < 3.6 V		±1		dB
2nd and 3rd harmonics	2fo, 3fo ³	$P_{OUT} = +20 \text{ dBm}, \text{BDR}, \text{GFSK}$			-42	dBm/MHz
Input return loss	S11			-10		dB
Turn-on time	trise	From 50% of CTX edge to 90% of final RF power		800		ns
Turn-off time	tFALL	From 50% of CTX edge to 90% of final RF power		800		ns
Stability	STAB	CW, PIN=0 dBm, 0.1 GHz to 20 GHz, load VSWR = $6:1$	All non-har	monically relate	ed outputs < -42	2 dBm/MHz
Ruggedness	RUG	CW, PIN =0 dBm, load VSWR = 10:1		No perman	ent damage	
Bypass Characteristics						
Frequency range	f		2400		2483	MHz
Bypass gain	BYP_gain			-1.7		dB
Input return loss	S11			-10		dB
Output return loss	S22			-12		dB

Table 5. SKY66118-11 Electrical Specifications¹

(Vcc1 = 3.0 V, Vcc2 = 3.0 V, VcTRL = 3.0 V, TA = +25 °C, All Unused Ports Terminated with 50 Ω , Unless Otherwise Noted)

¹ Performance is guaranteed only under the conditions listed in this table.

² POUT can be controlled by varying the VCTRL. See Figures 3 through 6.

³ Guaranteed by characterization.

Table 6. SKY66118-11 Mode Control Logic

Mode	Description	CSD	CTX
0	ALL OFF (sleep mode)	0	Х
1	Transmit mode	1	1
2	Bypass mode	1	0

VCTRL Pin Usage

The SKY66118-11 VCTRL pin supplies the bias to the internal PA. By varying the voltage at this pin, PA operating parameters including gain, supply current, and efficiency can be adjusted.

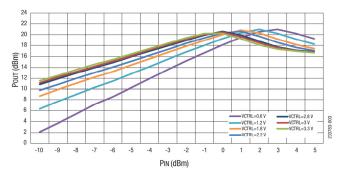


Figure 3. Pout vs PIN vs Vctrl (Vcc1 = Vcc2 = 3 V), f = 2440 MHz, CW

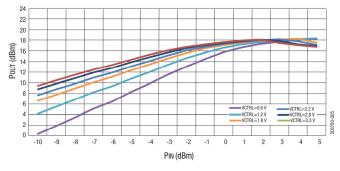


Figure 5. Pout vs PIN vs VCTRL (VCC1 = VCC2 = 1.8 V), f = 2440 MHz, CW

The VCTRL pin can also be used to adjust the SKY66118-11 output power when the RF source (transceiver or baseband) has a fixed level.

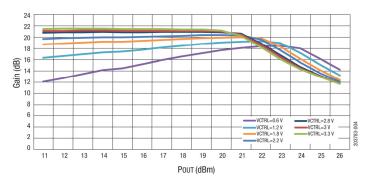


Figure 4. Gain vs Pout vs Vctrl (Vcc1 = Vcc2 = 3 V), f = 2440 MHz, CW

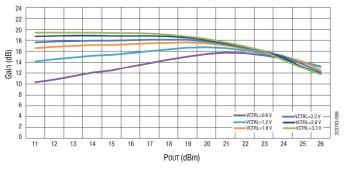


Figure 6. Gain vs Pout vs Vctrl (Vcc1 = Vcc2 = 1.8 V), f = 2440 MHz, CW

Application Schematic Description

A reference design schematic is provided in Figure 7. An evaluation board schematic diagram is shown in Figure 8.

A photograph of the Evaluation Board is shown in Figure 9. The Evaluation Board Bill of Materials (BOM) is shown in Table 7.

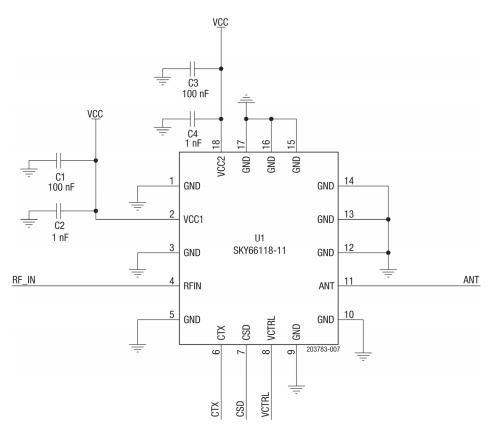


Figure 7. SKY66118-11 Reference Design Schematic

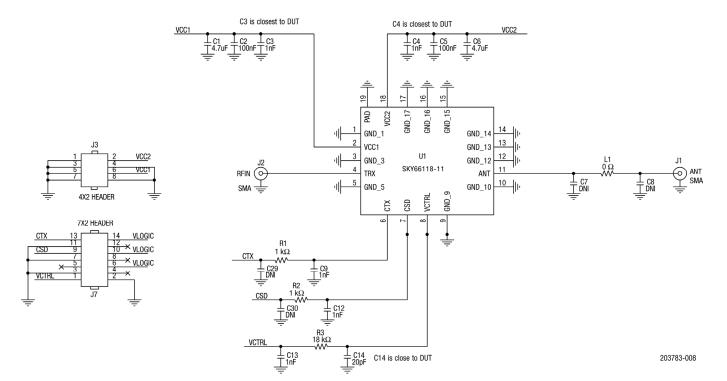


Figure 8. SKY66118-11 Evaluation Board Schematic Diagram

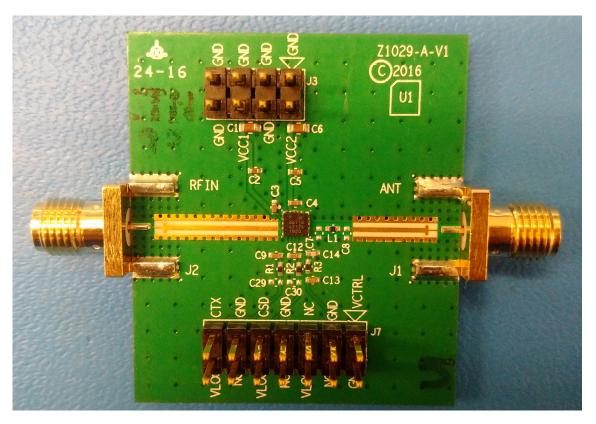


Figure 9. SKY66118-11 Evaluation Board Photograph

Quantity	Reference	Value	Manufacturer	Mfr Part Number	Package
2	C1, C6	4.7 uF	Murata	GRM188C71A475KE11D	0603
2	C2, C5	100 nF	Murata	GRM155R71C104KA88D	0402
5	C3, C4, C9, C12, C13	1 nF	Murata	GRM155R71H102KA01	0402
4	C7, C8, C29, C30	DNI			0402
1	C14	20 pF	Murata	GJM1555C1H200GB01	0402
4	J1, J2	SMA	Johnson Components	142-0701-851	end launch
1	J3	4X2 HEADER	Samtec	TSW-104-07-G-D	100 mil
1	J7	7X2 HEADER	Samtec	TSW-107-07-G-D	100 mil
2	L1	0 Ω	Panasonic	ERJ2GE0R00	0402
1	PCB1	Z1029-A-V1			
2	R1, R2	1 kΩ	Panasonic	ERJ2GEJ102	0402
1	R3	18 kΩ	Panasonic	ERJ2GEJ183	0402
1	U1	SKY66118-11	Skyworks Solutions	SKY66118-11	MCM2.4X2.6

Table 7. SKY66118-11 Evaluation Board Bill of Materials (BOM)

Package Dimensions

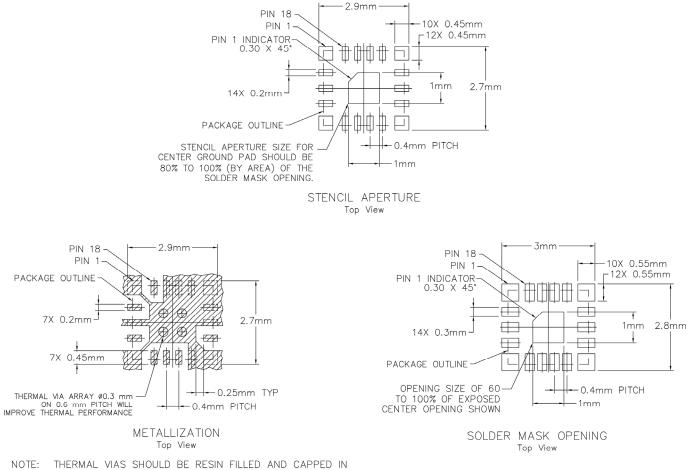
The PCB layout footprint for the SKY66118-11 is provided in Figure 10. The typical part marking is shown in Figure 11. Package dimensions are shown in Figure 12, and tape and reel dimensions are provided in Figure 13.

Package and Handling Information

Since the device package is sensitive to moisture absorption, it is baked and vacuum packed before shipping. Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

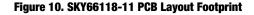
The SKY66118-11 is rated to Moisture Sensitivity Level 3 (MSL3) at 260 °C. It can be used for lead or lead-free soldering. For additional information, refer to the Skyworks Application Note, *PCB Design and SMT Assembly/Rework Guidelines for MCM-L Packages*, document number 101752.

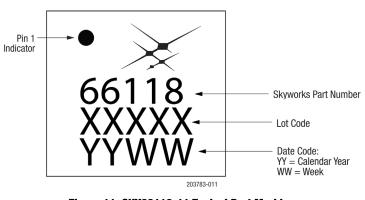
Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format.



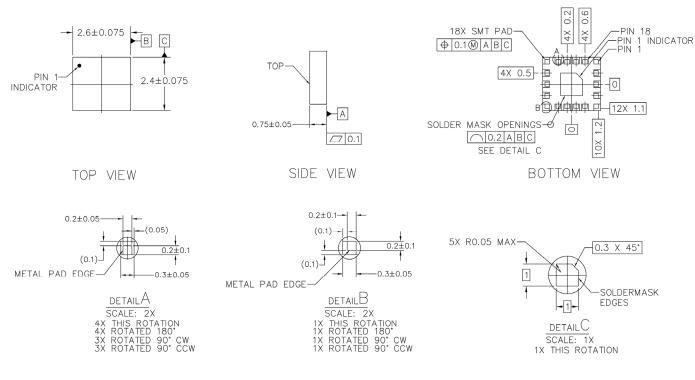
NOTE: THERMAL VIAS SHOULD BE RESIN FILLED AND CAPPED IN ACCORDANCE WITH IPC-4761 TYPE VII VIAS. 30-35UM Cu THICKNESS IS RECOMMENDED.

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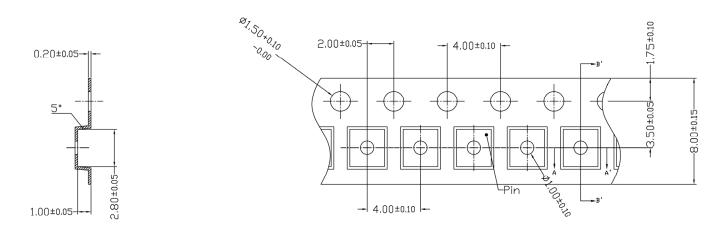


NOTES: UNLESS OTHERWISE SPECIFIED. 1. DIMENSIONING AND TOLERANCING IN ACCORDANCE WITH ASME Y14.5M-1994. 2. DIMENSIONS ARE IN MILLIMETERS

Figure 12. SKY66118-11 Package Dimensions

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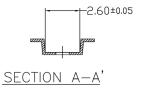
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SECTION B-B'

- 1. CARRIER TAPE MUST MEET ALL SKYWORKS REQUIREMENTS OF GP01-D233 PROCUREMENT SPEC FOR TAPE AND REEL
- ② CARRIER TAPE SHALL BE BLACK CONDUCTIVE POLYCARBONATE NON BAKEABLE.
- 3. COVER TAPE SHALL BE TRANSPARENT CONDUCTIVE MATERIAL
- 4. ESD-SURFACE RESISTIVITY SHALL MEET GP01-D233
- 5. 10 SPROCKET HOLE PITCH CUMULATIVE TOLERANCE : ±0.20mm
- 6. AO & BO MEASURED ON PLANE 0.30mm ABOVE THE BOTTOM OF THE POCKET.
- 7. ALL DIMENSIONS ARE IN MILLIMETERS.

Figure 13. SKY66118-11 Tape and Reel Dimensions



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